

### Features

- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- Positive Temperature Coefficient on  $V_F$
- Temperature-independent Switching
- 175°C Operating Junction Temperature

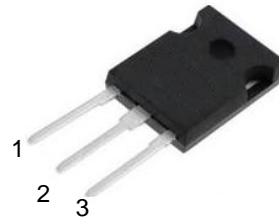
$V_{RRM}$	=	650	V
$I_F (T_c \leq 135^\circ\text{C})$	=	26	A**
$Q_C$	=	50	nC**

\*Per Leg, \*\*Per Device

### Benefits

- Replace Bipolar with Unipolar Device
- Reduction of Heat Sink Size
- Parallel Devices Without Thermal Runaway
- Essentially No Switching Losses

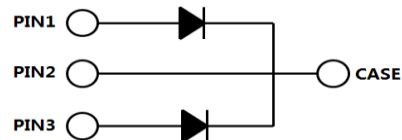
### Package



TO-247-3

### Applications

- Switch Mode Power Supplies
- Power Factor Correction
- Motor drive, PV Inverter, Wind Power Station



Part Number	Package	Marking
AS3D020065P2	TO-247-3	ASD2065P2

### Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	650	V	T <sub>C</sub> = 25°C	
V <sub>RSM</sub>	Surge Peak Reverse Voltage	650	V	T <sub>C</sub> = 25°C	
V <sub>R</sub>	DC Blocking Voltage	650	V	T <sub>C</sub> = 25°C	
I <sub>F</sub>	Forward Current (Per leg/Device)	27.5/55 13/26 10/20	A	T <sub>C</sub> ≤ 25°C T <sub>C</sub> ≤ 135°C T <sub>C</sub> ≤ 149°C	
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current	90*	A	T <sub>C</sub> = 25°C, t <sub>p</sub> = 8.3ms, Half Sine Wave	
P <sub>tot</sub>	Power Dissipation (Per leg/Device)	141/ 282	W	T <sub>C</sub> = 25°C	Fig.3
T <sub>C</sub>	Maximum Case Temperature	149	°C		
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature	-55 to 175	°C		
	TO-247-3 Mounting Torque	1	Nm	M3 Screw	

### Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V <sub>F</sub>	Forward Voltage	1.4 1.75	1.65 2.3	V	I <sub>F</sub> = 10A, T <sub>J</sub> = 25°C I <sub>F</sub> = 10A, T <sub>J</sub> = 175°C	Fig.1
I <sub>R</sub>	Reverse Current	1 5	20 100	μA	V <sub>R</sub> = 650V, T <sub>J</sub> = 25°C V <sub>R</sub> = 650V, T <sub>J</sub> = 175°C	Fig.2
C	Total Capacitance	618 61 51	/	pF	V <sub>R</sub> = 0V, T <sub>J</sub> = 25°C, f = 1MHz V <sub>R</sub> = 200V, T <sub>J</sub> = 25°C, f = 1MHz V <sub>R</sub> = 400V, T <sub>J</sub> = 25°C, f = 1MHz	Fig.5
Q <sub>C</sub>	Total Capacitive Charge	25	/	nC	V <sub>R</sub> = 650V, I <sub>F</sub> = 10A di/dt = 200A/μs, T <sub>J</sub> = 25°C	Fig.4

### Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Note
R <sub>θJC</sub>	Thermal Resistance from Junction to Case	1.06* 0.53**	°C/W	Fig.6
R <sub>θJA</sub>	Thermal Resistance from Junction to Ambient	80	°C/W	
T <sub>sold</sub>	Soldering Temperature	260	°C	

\*Per Leg, \*\*Per Device

## Typical Performance (Per Leg)

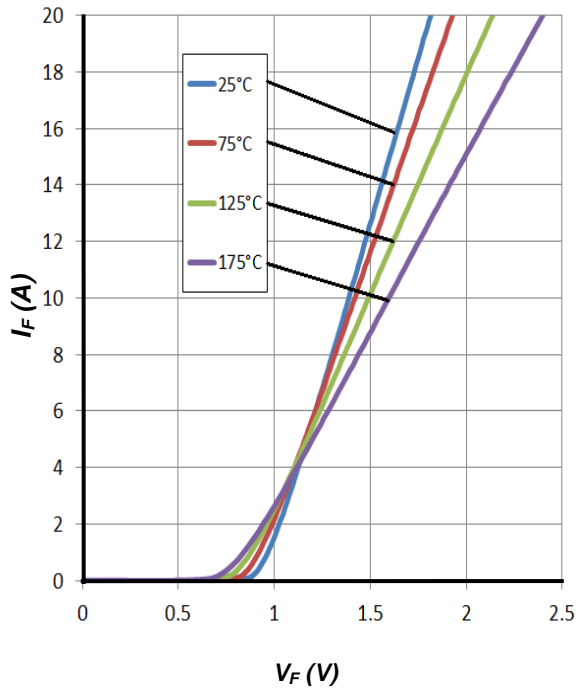


Figure 1. Forward Characteristics

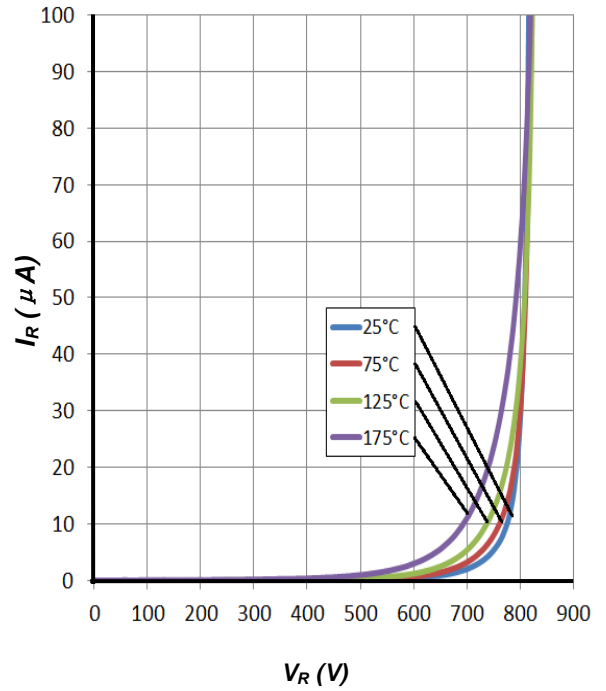


Figure 2. Reverse Characteristics

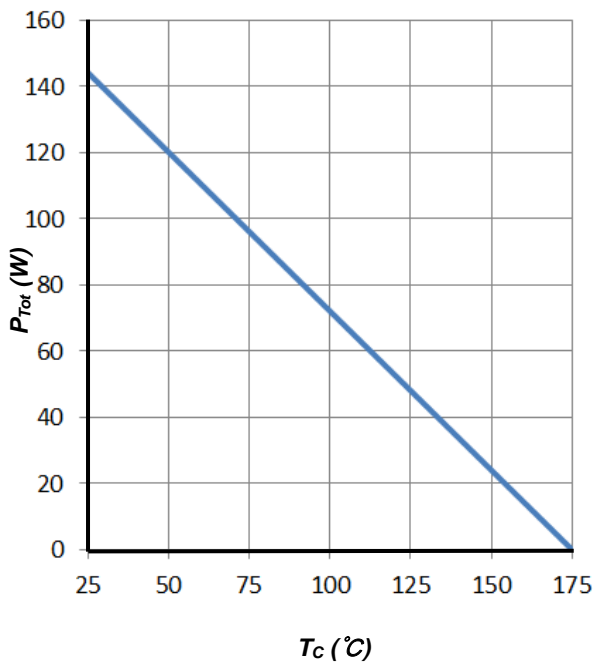


Figure 3. Power Derating

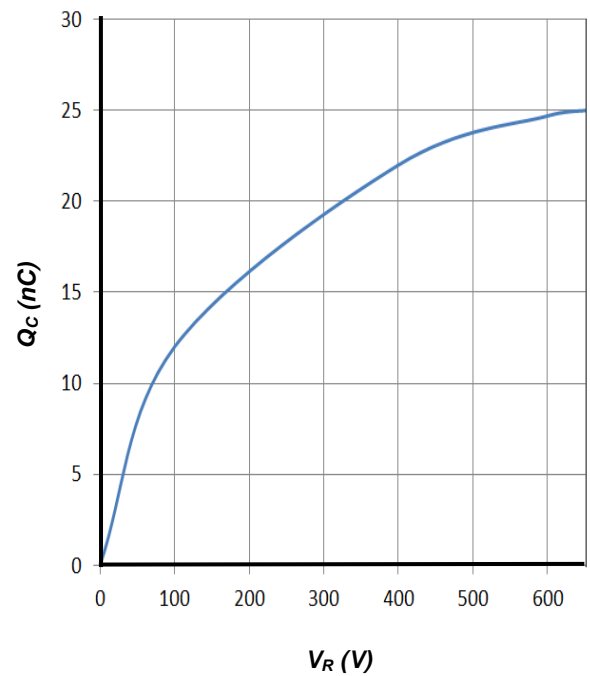


Figure 4. Total Capacitive Charge vs. Reverse Voltage

## Typical Performance (Per Leg)

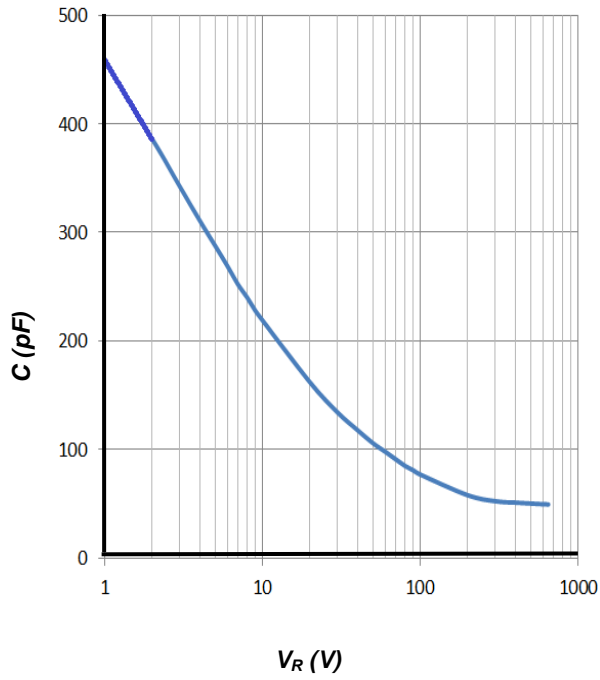


Figure 5. Total Capacitance vs. Reverse Voltage

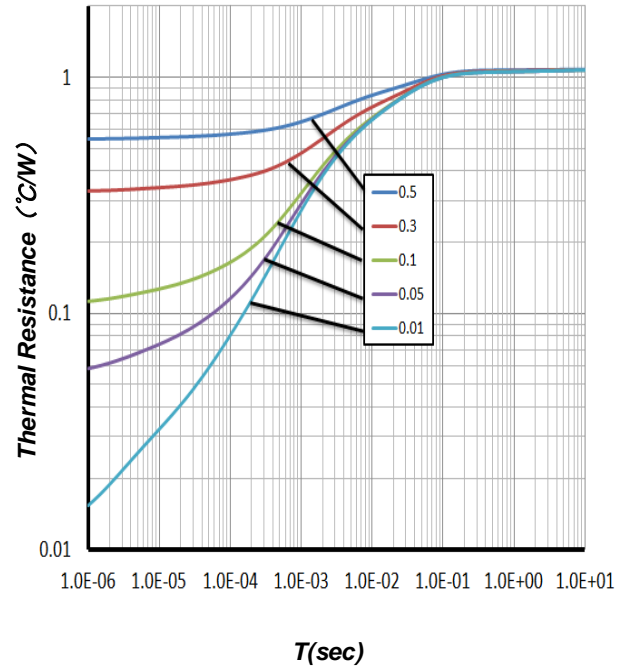
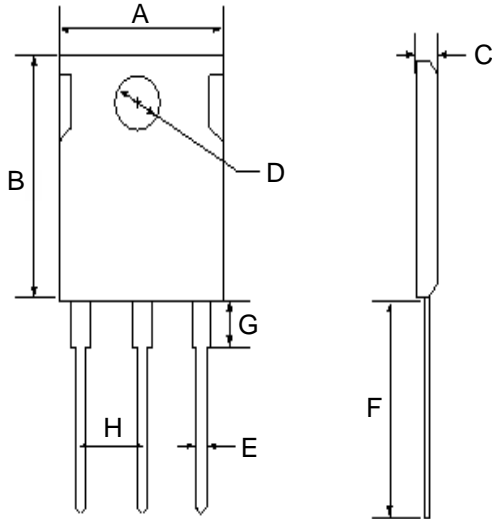


Figure 6. Transient Thermal Impedance

### Package Dimensions

Package TO-247-3



Symbol	Min. (mm)	Typ. (mm)	Max. (mm)
A	14.18	15.75	17.33
B	18.45	20.5	22.55
C	4.50	5.00	5.50
D	3.15	3.50	3.85
E	1.08	1.20	1.32
F	18.27	20.30	22.33
G	4.21	4.68	5.15
H	4.91	5.46	6.01